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09/912,064 07/25/2001 Takahiro Oka TAI 129 23995 7590 07/08/2003 RABIN & CHAMPAGNE, PC 1101 14TH STREET, NW	3312	
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HOT 14TH STREET, NW	NER	
	ERDEM, FAZLI UNIT PAPER NUMBER	
WASHINGTON, DC 20005		
2826	· · · · · · ·	

Please find below and/or attached an Office communication concerning this application or proceeding.

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	,	Application No.	Applicant(s)			
ر.		09/912,064	OKA ET AL.	V		
	Office Action Summary	Examiner	Art Unit			
		Fazli Erdem	2826			
Period fo	The MAILING DATE of this communication apported to the second section apport.	pears on the cover sheet w	with the correspondence ac	Idress		
THE - Exte after - If the - If NO - Failu - Any	ORTENED STATUTORY PERIOD FOR REPL MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.1 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a repl period for reply is specified above, the maximum statutory period to reto reply within the set or extended period for reply will, by statute reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a y within the statutory minimum of th will apply and will expire SIX (6) MO	reply be timely filed irty (30) days will be considered timel NTHS from the mailing date of this c	y. ommunication.		
1)🖂	Responsive to communication(s) filed on <u>02 l</u>	December 2002 .				
2a)□		is action is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims						
4)⊠	Claim(s) 1 and 3-14 is/are pending in the app	ication.	NATHAN J. FLYNN			
1	4a) Of the above claim(s) is/are withdra			7		
5)	Claim(s) is/are allowed.	SUPE	RVISORY PATENT CANOLOGY CENTED 2800			
	Claim(s) <u>1 and 3-14</u> is/are rejected.	10				
	Claim(s) is/are objected to.					
	Claim(s) are subject to restriction and/o	r election requirement.				
	on Papers					
9) 🗌 -	The specification is objected to by the Examine	r.				
10) 🔲 -	The drawing(s) filed on is/are: a)□ accep	oted or b) objected to by	the Examiner.			
	Applicant may not request that any objection to the	e drawing(s) be held in abey	yance. See 37 CFR 1.85(a).			
11)☐ The proposed drawing correction filed on is: a)☐ approved b)☐ disapproved by the Examiner.						
	If approved, corrected drawings are required in rep	oly to this Office action.				
12) 🗌 🗆	The oath or declaration is objected to by the Ex	aminer.				
Priority u	ınder 35 U.S.C. §§ 119 and 120					
13)	Acknowledgment is made of a claim for foreign	priority under 35 U.S.C.	§ 119(a)-(d) or (f).			
a)[☐ All b)☐ Some * c)☐ None of:					
	1. Certified copies of the priority documents	s have been received.				
	2. Certified copies of the priority documents	s have been received in A	Application No			
	3. Copies of the certified copies of the prior application from the International Buree the attached detailed Office action for a list	ity documents have beer eau (PCT Rule 17.2(a)).	n received in this National	Stage		
	cknowledgment is made of a claim for domesti			application).		
a)	☐ The translation of the foreign language pro	visional application has b	peen received.	,.		
Attachment						
2) Notice 3) Inform	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of	Summary (PTO-413) Paper No(Informal Patent Application (PTO	s) O-152)		
.S. Patent and Tre PTO-326 (Rev		ion Summary	Part of Paper No. 10			

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DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 1. Claims 1, 3-14 rejected under 35 U.S.C. 103(a) as being unpatentable over Chen (6,118,184) in view of Ishio et al. (6,118,184) further in view of Kim et al. (KR 2002042958) further in view of Han et al. (KR 200103663)

Regarding Claims 1, 3-14, Chen discloses multi-chips semiconductor package and fabrication method where multi-chips semiconductor package and fabrication method mainly combines LOC and BGA techniques to overlap one chip upon another chip in an IC component package. One chip uses leads of a lead frame as connection interface of the circuit in the chip to outside. Another chip uses solder balls as connection interface of the circuit in another chip to outside. The two chips are supported by the lead frame without a substrate used in a conventional BGA package. The two chips may have same or different function. Chen fails to disclose the required bonding structure, bond wiring structure and the bond wiring structure in the specified manner. However, Ishio et al. disclose a semiconductor device sealed with a sealing resin and including structure to balance sealing resin flow where the required bonding structure is disclosed. Furthermore, Kim et al. disclose stacked chip packages where the required bond wiring structure is disclosed. Finally, Han et al. disclose stacked chip packages where the required bond wiring in the specified manner is disclosed.

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It would have been obvious to one of having ordinary skill in the art at the time the

invention was made to include the required bonding structure, bond wiring structure and the

bond wiring structure in the specified manner in Chen as taught by Ishio et al., Kim et al, and

Han et al respectively in order to have stacked semiconductor chips with better

manufacturability.

Conclusion

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Fazli Erdem whose telephone number is (703) 305-3868. The

examiner can normally be reached on M - F 8:00 - 5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Nathan Flynn can be reached on (703) 308-6601. The fax phone numbers for the

organization where this application or proceeding is assigned are (703) 308-7722 for regular

communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding

should be directed to the receptionist whose telephone number is (703) 308-0956.

FE

June 30, 2003